

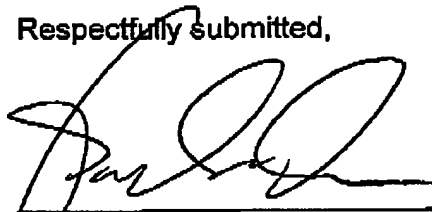
Application Serial No. 10/782,557  
Docket: CU-3590

PATENT

**REMARKS/ARGUMENTS**

Claims 1-17 were pending before this amendment. By the present amendment, claims 17 is amended to recite "The semiconductor device substrate...". No new matter has been added.

Respectfully submitted,

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